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Part Number: [0717640114](#)
Status: **Active**
Description: 2.54mm (.100") Pitch C-Grid® Breakaway Header, Low Profile, Dual Row, Right Angle, High Temperature, 14 Circuits, 0.38µm (15µ") Gold (Au) Selective Plating

Documents:

3D Model	Product Specification PS-71764 (PDF)
Packaging Specification (PDF)	RoHS Certificate of Compliance (PDF)
Drawing (PDF)	

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	PCB Headers
Series	71764
Application	Board-to-Board, Wire-to-Board
Product Name	C-Grid®

Physical

Breakaway	Yes
Circuits (Loaded)	14
Circuits (maximum)	14
Color - Resin	Black
Durability (mating cycles max)	50
Flammability	94V-0
Glow-Wire Compliant	No
Lock to Mating Part	None
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Number of Rows	2
Orientation	Right Angle
PC Tail Length (in)	0.110 In
PC Tail Length (mm)	2.79 mm
PCB Locator	No
PCB Retention	None
Packaging Type	Tube
Pitch - Mating Interface (in)	0.100 In
Pitch - Mating Interface (mm)	2.54 mm
Plating min: Mating (µin)	15
Plating min: Mating (µm)	0.375
Plating min: Termination (µin)	75
Plating min: Termination (µm)	1.875
Polarized to Mating Part	No
Shrouded	No
Stackable	Yes
Temperature Range - Operating	-40°C to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	3A
Voltage - Maximum	250V

Solder Process Data

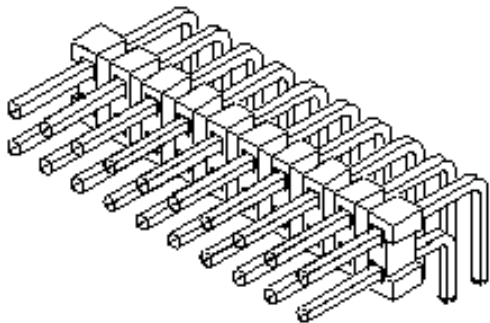


image - Reference only

Series

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[71764Series](#)

Duration at Max. Process Temperature (seconds)	30
Lead-free Process Capability	SMC & Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	3
Process Temperature max. C	265

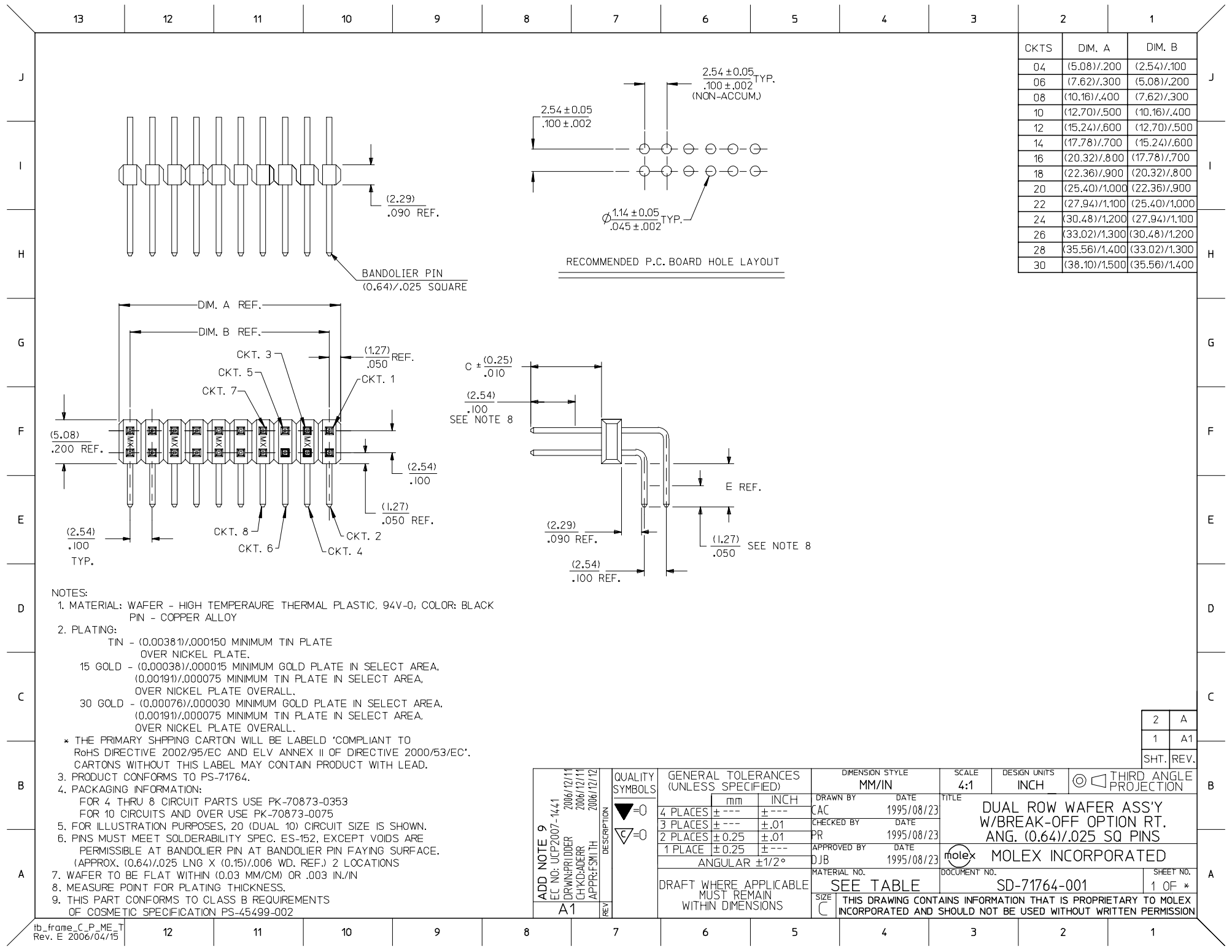
Material Info

Reference - Drawing Numbers

Product Specification	PS-71764
Sales Drawing	SD-71764-001

This document was generated on 03/31/2010

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CKTS	DIM. A	DIM. B
04	(5.08)/.200	(2.54)/.100
06	(7.62)/.300	(5.08)/.200
08	(10.16)/.400	(7.62)/.300
10	(12.70)/.500	(10.16)/.400
12	(15.24)/.600	(12.70)/.500
14	(17.78)/.700	(15.24)/.600
16	(20.32)/.800	(17.78)/.700
18	(22.86)/.900	(20.32)/.800
20	(25.40)/1.000	(22.86)/.900
22	(27.94)/1.100	(25.40)/1.000
24	(30.48)/1.200	(27.94)/1.100
26	(33.02)/1.300	(30.48)/1.200
28	(35.56)/1.400	(33.02)/1.300
30	(38.10)/1.500	(35.56)/1.400

- NOTES:
- MATERIAL: WAFER - HIGH TEMPERATURE THERMAL PLASTIC, 94V-0; COLOR: BLACK
PIN - COPPER ALLOY
 - PLATING:
 - TIN - (0.00381)/.000150 MINIMUM TIN PLATE OVER NICKEL PLATE.
 - 15 GOLD - (0.000381)/.000015 MINIMUM GOLD PLATE IN SELECT AREA, (0.00191)/.000075 MINIMUM TIN PLATE IN SELECT AREA, OVER NICKEL PLATE OVERALL.
 - 30 GOLD - (0.00076)/.000030 MINIMUM GOLD PLATE IN SELECT AREA, (0.00191)/.000075 MINIMUM TIN PLATE IN SELECT AREA, OVER NICKEL PLATE OVERALL.
 - * THE PRIMARY SHIPPING CARTON WILL BE LABELED 'COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC'. CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH LEAD.
 - PRODUCT CONFORMS TO PS-71764.
 - PACKAGING INFORMATION:
 - FOR 4 THRU 8 CIRCUIT PARTS USE PK-70873-0353
 - FOR 10 CIRCUITS AND OVER USE PK-70873-0075
 - FOR ILLUSTRATION PURPOSES, 20 (DUAL 10) CIRCUIT SIZE IS SHOWN.
 - PINS MUST MEET SOLDERABILITY SPEC. ES-152, EXCEPT VOIDS ARE PERMISSIBLE AT BANDOLIER PIN AT BANDOLIER PIN FAYING SURFACE. (APPROX. (0.64)/.025 LRG X (0.15)/.006 WD. REF.) 2 LOCATIONS
 - WAFER TO BE FLAT WITHIN (0.03 MM/CM) OR .003 IN/IN
 - MEASURE POINT FOR PLATING THICKNESS.
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002

ADD NOTE 9 EC NO: UCP2007-1441 DRAWN BY: DER CHKD: ADERR APPR: FSM TH A1	DESCRIPTION QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION			
			MM/IN		4:1	INCH				
			mm	INCH	DRAWN BY	DATE	TITLE DUAL ROW WAFER ASS'Y W/BREAK-OFF OPTION RT. ANG. (0.64)/.025 SQ PINS			
					CAC	1995/08/23				
					CHECKED BY	DATE	APPROVED BY			
					PR	1995/08/23				
					DATE		MOLEX MOLEX INCORPORATED			
		1995/08/23								
		ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-71764-001		1 OF *		
				SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

ITEM NO: 71764-0004/0030, 9003			ITEM NO: 71764-0104/0130, 9001, 9004			ITEM NO: 71764-0204/0230, 9000, 9002		
DIM. C		(6.10)/.240	DIM. C		(6.10)/.240	DIM. C		(6.10)/.240
DIM. E (REF.)		(2.79)/.110	DIM. E (REF.)		(2.79)/.110	DIM. E (REF.)		(2.79)/.110
FINISH		TIN	FINISH		15 GOLD	PLATING FINISH		30 GOLD
CONNECTOR END PLATING		TIN	CONNECTOR END PLATING		GOLD	CONNECTOR END PLATING		GOLD
P.C. BOARD END PLATING		TIN	P.C. BOARD END PLATING		TIN	P.C. BOARD END PLATING		TIN
PACKAGING		SEE NOTE 4 SHEET 1	PACKAGING		SEE NOTE 4 SHEET 1	PACKAGING		SEE NOTE 4 SHEET 1
CKTS	ITEM NUMBER	VOIDS	CKTS	ITEM NUMBER	VOIDS	CKTS	ITEM NUMBER	VOIDS
04	71764-0004		04	71764-0104		04	71764-0204	
06	71764-0006		06	71764-0106		06	71764-0206	
08	71764-0008		08	71764-0108		08	71764-0208	
10	71764-0010		10	71764-0110		10	71764-0210	
12	71764-0012		12	71764-0112		12	71764-0212	
14	71764-0014		14	71764-0114		14	71764-0214	
16	71764-0016		16	71764-0116		16	71764-0216	
18	71764-0018		18	71764-0118		18	71764-0218	
20	71764-0020		20	71764-0120		20	71764-0220	
22	71764-0022		22	71764-0122		22	71764-0222	
24	71764-0024		24	71764-0124		24	71764-0224	
26	71764-0026		26	71764-0126		26	71764-0226	
28	71764-0028		28	71764-0128		28	71764-0228	
30	71764-0030		30	71764-0130		30	71764-0230	
06	71764-9003	3	06	71764-9001	3, 4	06	71764-9002	3, 4
			08	71764-9004	5, 6			
						10	71764-9000	8

REV: A	<u>ECR/ECN INFORMATION</u>		<u>TITLE:</u> DUAL ROW WAFER ASS'Y W/ BREAK-OFF OPTION RT. ANG. (0.64)/.025 SQ PINS			<u>SHEET No.</u> - 2 -		
	<u>EC No:</u> UCP2007-0449							
	<u>DATE:</u> 2006-08-18							
<u>DOCUMENT NUMBER:</u> SD-71764-001			<u>CREATED / REVISED BY:</u> PRIDDER		<u>CHECKED BY:</u> ADERR		<u>APPROVED BY:</u> FSMITH	

ITEM NO: 71764-0304/0330			ITEM NO: 71764-0404/0430			ITEM NO: 71764-0504/0530		
DIM. C		(8.13)/.320	DIM. C		(8.13)/.320	DIM. C		(8.13)/.320
DIM. E (REF.)		(2.79)/.110	DIM. E (REF.)		(2.79)/.110	DIM. E (REF.)		(2.79)/.110
PLATING FINISH		TIN	PLATING FINISH		15 GOLD	PLATING FINISH		30 GOLD
CONNECTOR END PLATING		TIN	CONNECTOR END PLATING		GOLD	CONNECTOR END PLATING		GOLD
P.C. BOARD END PLATING		TIN	P.C. BOARD END PLATING		TIN	P.C. BOARD END PLATING		TIN
PACKAGING		SEE NOTE 4 SHEET 1	PACKAGING		SEE NOTE 4 SHEET 1	PACKAGING		SEE NOTE 4 SHEET 1
CKTS	ITEM NUMBER	VOIDS	CKTS	ITEM NUMBER	VOIDS	CKTS	ITEM NUMBER	VOIDS
04	71764-0304		04	71764-0404		04	71764-0504	
06	71764-0306		06	71764-0406		06	71764-0506	
08	71764-0308		08	71764-0408		08	71764-0508	
10	71764-0310		10	71764-0410		10	71764-0510	
12	71764-0312		12	71764-0412		12	71764-0512	
14	71764-0314		14	71764-0414		14	71764-0514	
16	71764-0316		16	71764-0416		16	71764-0516	
18	71764-0318		18	71764-0418		18	71764-0518	
20	71764-0320		20	71764-0420		20	71764-0520	
22	71764-0322		22	71764-0422		22	71764-0522	
24	71764-0324		24	71764-0424		24	71764-0524	
26	71764-0326		26	71764-0426		26	71764-0526	
28	71764-0328		28	71764-0428		28	71764-0528	
30	71764-0330		30	71764-0430		30	71764-0530	

REV: A	<u>ECR/ECN INFORMATION</u>		<u>TITLE:</u> DUAL ROW WAFER ASS'Y W/ BREAK-OFF OPTION RT. ANG. (0.64)/.025 SQ PINS			<u>SHEET No.</u> - 3 -		
	<u>EC No:</u> UCP2007-0449							
	<u>DATE:</u> 2006-08-18							
<u>DOCUMENT NUMBER:</u> SD-71764-001			<u>CREATED / REVISED BY:</u> PRIDDER		<u>CHECKED BY:</u> ADERR		<u>APPROVED BY:</u> FSMITH	